





YI J I N ELECTRONI CS CO., LTD

# 产品承认书

# **Product acknowledgment**

Client客户:	
Product产品:	声表面谐振器
Model型号:	R433.92M 3030mm
Tabulation 制表:	Production
Date日期:	2011-5-1

承認結果	客戶簽名	客戶承認章	日期	備注
CONCLUSION	SIGNATURE	STAMP	DATE	REMARK
合格				
ACCEPT				
不合格				
REJECT				

审核:	
, ,,,,	(请盖公章)

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# 1. Scope

This specification shall cover the characteristics of 1-port SAW resonator with R433.92 used for remote-control security.

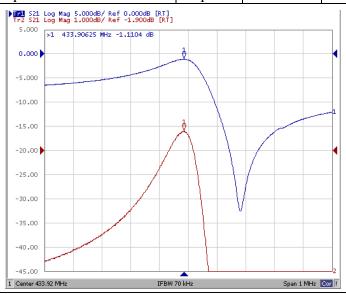
# 2. Electrical Specification

### 2.1 Maximum Rating

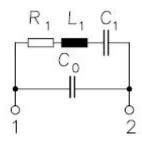
DC Voltage VDC	10V
AC Voltage Vpp	10V 50Hz/60Hz
Operation temperature	-40°C to +85°C
Storage temperature	-45°C to +85°C
Source Power	0dBm

#### 2.2 Electronic Characteristics

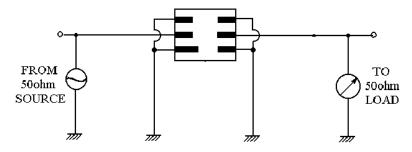
Item			Unites	Minimum	Typical	Maximum
Center Freque	ency		MHz	433.845	433.92	433.995
Insertion Loss	S		dB		1.4	1.9
Unload Q			8000	12800		
Quality Facto	1	50Ω Loaded Q		1000	2000	
Temperature	Turnov	er Temperature	$^{\circ}$ C	10	25	40
Stability	Freq.te	mp.Coefficient	ppm/℃		0.032	
Frequency Ag		ppm/yr		<±10		
DC. Insulation Resistance			ΜΩ	1.0		
RF	Motion	al Resistance R1	Ω		17	26
Equivalent	Motion	al Inductance L1	μН		70.743	
RLC Model	Motion	al Capacitance C1	fF		1.9018	
Transducer Static Capacitance C0			pF		2.0	



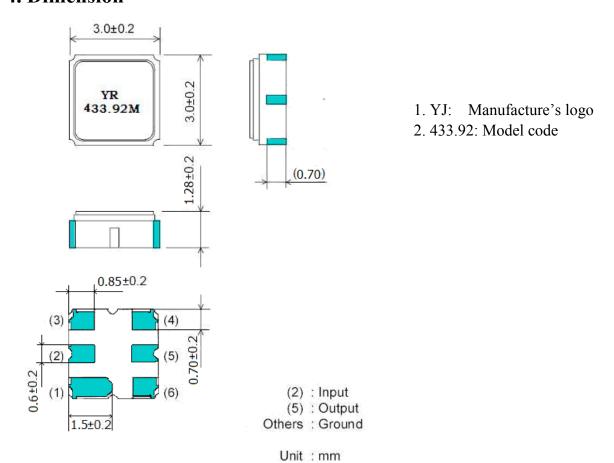
### 2.3 Equivalent LC Model



# 3. Test Circuit



# 4. Dimension



### 5. Environment Characteristic

#### 5-1 Thermal Shock:

The components shall remain within the electrical specifications after being kept at the condition of heat cycle conditions: TA=-40 °C±3 °C, TB=85 °C±2 °C, t1=t2=30min, switch time $\leq$ 3min& cycle time : 100 times, recovery time: 2h±0.5h.

#### 5-2 Resistance to solder heat

Submerge the device terminals into the solder bath at  $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$  for  $10\pm 1$  sec. Then release the device into the room conditions for 4 hours. It shall meet the specifications in 2.2.

#### 5-3 Solder ability

Submerge the device terminals into the solder bath at  $245^{\circ}$ C  $\pm 5^{\circ}$ C for 5s, More than 95% area of the soldering pad must be covered with new solder. It shall meet the specifications in 2.2

#### 5-4 The Temperature Storage:

- 5.3.1 High Temperature Storage: The components shall remain within the electrical specifications after being kept at the 85°C±2°C for 96h±4h, recovery time: 2h±0.5h.
- 5.3.2 Low Temperature Storage: The components shall remain within the electrical specifications after being kept at the  $-40^{\circ}\text{C} \pm 3^{\circ}\text{C}$  for 96h±4h, recovery time : 2h±0.5h.

#### 5-5 Humidity test:

The components shall remain within the electrical specifications after being kept at the condition of ambient temperature  $60^{\circ}\text{C}\pm2^{\circ}\text{C}$ , and  $90\sim96\%$  RH for  $96\text{h}\pm4\text{h}$ .

#### 5-6 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1m for 3 times. The resonator shall fulfill the specifications in 2.2.

#### 5-7 Vibration

Subject the device to the vibration for 2 hour each in X, Y and Z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The resonator shall fulfill the specifications in 2.2.

#### 6. Remark

#### 6.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

#### 6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

#### **SAW RESONATOR**

#### 6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.

## 7. Packing

#### 7.1 Dimensions

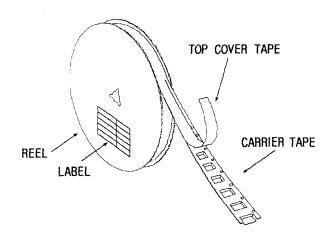
- (1) Carrier Tape: Figure 1
- (2) Reel: Figure 2
- (3) The product shall be packed properly not to be damaged during transportation and storage.

#### 7.2 Reeling Quantity

1000 pcs/reel 7" 3000 pcs/reel 13"

#### 7.3 Taping Structure

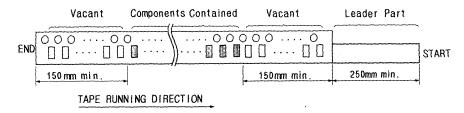
(1) The tape shall be wound around the reel in the direction shown below.



#### (2) Label

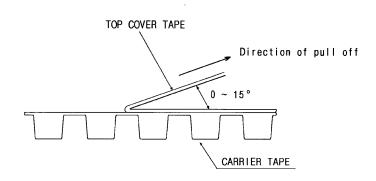
Device Name	
User Product Name	
Quantity	
Lot No.	

(3) Leader part and vacant position specifications.

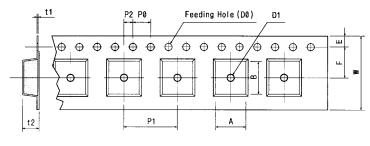


# 8. Tape Specifications

- 8.1 Tensile Strength of Carrier Tape: 4.4N/mm width
- 8.2 Top Cover Tape Adhesion (See the below figure)
  - (1) pull off angle: 0~15°
    (2) speed: 300mm/min.
    (3) force: 20~70g



[Figure 1] Carrier Tape Dimensions



Tape Running Direction

[Unit: mm]

W	F	Е	P0	P1	P2	D0	D1	t1	t2	A	В
12.0	5.5	1.75	4.0	4.0	2.0	Ø1.5	Ø1.0	0.3	1.25	3.3±	3.3±
$\pm 0.3$	±0.05	±0.1	±0.1	±0.1	$\pm 0.05$	±0.1	±0.25	$\pm 0.05$	±0.1	0.1	0.1

### **SAW RESONATOR**

[Figure 2] Reel Dimensions

